

NCE75H21TB

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE75H21TB uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

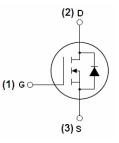
- $V_{DS} = 75V, I_D = 210A$ $R_{DS(ON)} < 4.0mΩ @ V_{GS} = 10V$ (Typ3.3mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE75H21TB	NCE75H21TB	TO-247	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	75	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	210	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	148	Α
Pulsed Drain Current	I _{DM}	850	Α
Maximum Power Dissipation	P _D	330	W



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Derating factor		2.2	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	2200	mJ	
Operating Junction and Storage Temperature Range	T_J, T_STG	-55 To 175	$^{\circ}\mathbb{C}$	

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.45	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	75	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =75V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			•
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	3.3	4.0	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =40A	60	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	\/ 20\/\/ 0\/	-	9400	-	PF
Output Capacitance	C _{oss}	V_{DS} =30V, V_{GS} =0V, F=1.0MHz	-	880	-	PF
Reverse Transfer Capacitance	C_{rss}	F=1.UIVIHZ	-	520	-	PF
Switching Characteristics (Note 4)			•			•
Turn-on Delay Time	t _{d(on)}		-	26.3	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1 Ω	-	48.8	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10V, R_{GEN} =2.5 Ω	-	87.5	-	nS
Turn-Off Fall Time	t _f		-	30	-	nS
Total Gate Charge	Qg	V 20VI 20A	-	228	-	nC
Gate-Source Charge	Q_{gs}	V _{DS} =30V,I _D =30A,	-	66	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	36	-	nC
Drain-Source Diode Characteristics			•			•
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	110	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	53	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	123	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

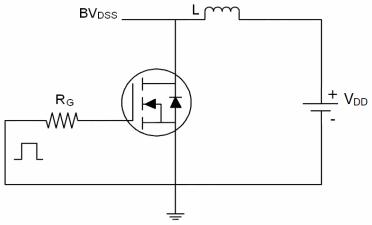
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}\text{C}$,VDD=37.5V,VG=10V,L=0.5mH,Rg=25 Ω

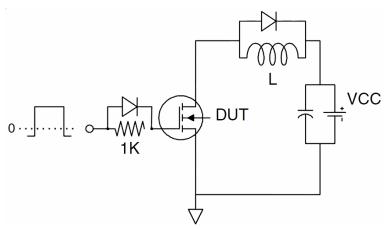


Test circuit

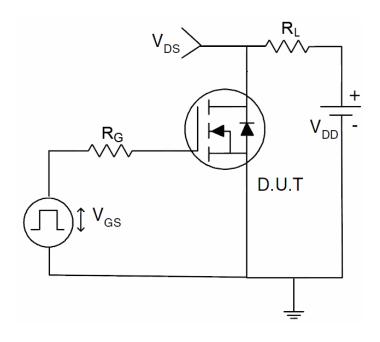
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

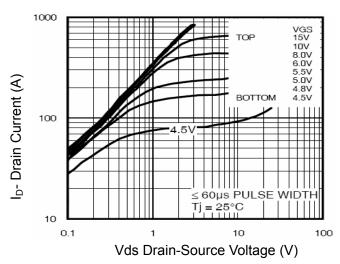


Figure 1 Output Characteristics

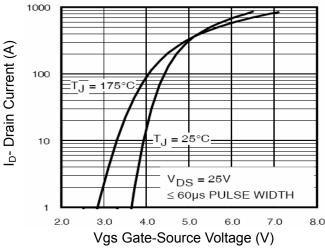


Figure 2 Transfer Characteristics

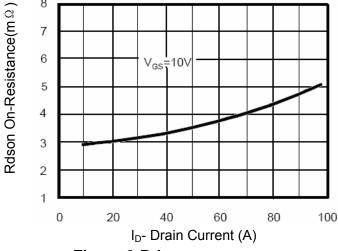


Figure 3 Rdson- Drain Current

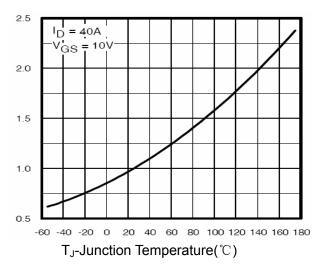


Figure 4 Rdson-JunctionTemperature

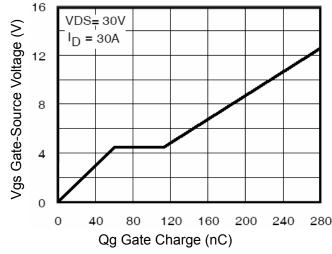


Figure 5 Gate Charge

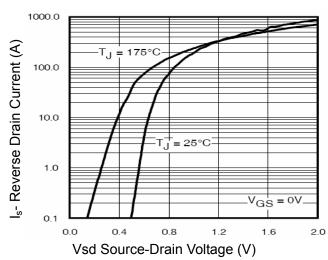
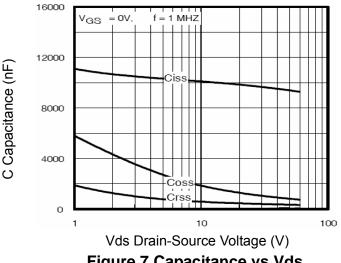


Figure 6 Source- Drain Diode Forward

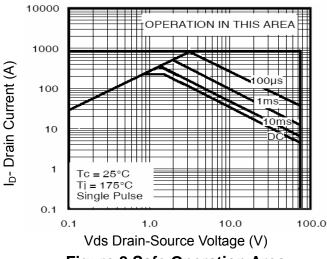




100 90 V(BR)DSS 80 70 -60 -40 -20 0 20 40 60 80 100 120 140 160 180 T_J -Junction Temperature($^{\circ}$ C)

Figure 7 Capacitance vs Vds

Figure 9 BV_{DSS} vs Junction Temperature



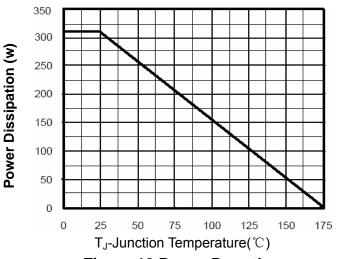


Figure 8 Safe Operation Area

Figure 10 Power De-rating

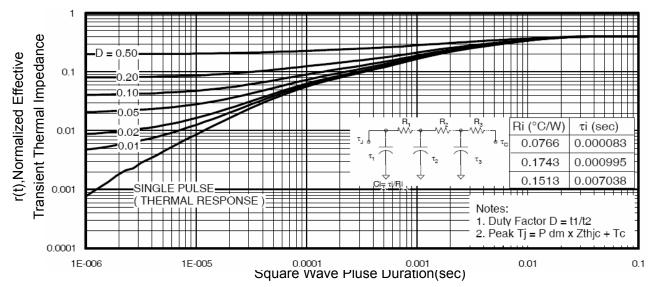


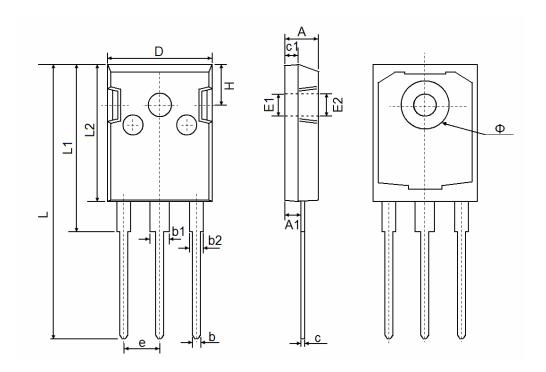
Figure 11 Normalized Maximum Transient Thermal Impedance

Pb Free Product



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TO-247 Package Information



Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.500 REF		0.138 REF		
E2	3.600) REF	0.142 REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Ф	7.100	7.300	0.280	0.287	
е	5.450) TYP	0.215 TYP		
Н	5.980) REF	0.235	REF	



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